## MOSFET - Small Signal, Complementary, SOT-963, $1.0 \times 1.0 \mathrm{~mm}$

## 20 V, 220 mA / -200 mA

## Features

- Complementary MOSFET Device
- Offers a Low $\mathrm{R}_{\mathrm{DS}(\mathrm{on})}$ Solution in the Ultra Small 1.0x1.0 mm Package
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile ( $<0.5 \mathrm{~mm}$ ) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics.
- This is a $\mathrm{Pb}-$ Free Device


## Applications

- Load Switch with Level Shift
- Optimized for Power Management in Ultra Portable Equipment

MAXIMUM RATINGS $\left(\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Parameter |  |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Drain-to-Source Voltage |  |  | $\mathrm{V}_{\text {DSS }}$ | 20 | V |
| Gate-to-Source Voltage |  |  | $\mathrm{V}_{\mathrm{GS}}$ | $\pm 8$ | V |
| N -Channel Continuous Drain Current (Note 1) | Steady State | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{D}}$ | 220 | mA |
|  |  | $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$ |  | 160 |  |
|  | $\mathrm{t} \leq 5 \mathrm{~s}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 280 |  |
| P-Channel Continuous Drain Current (Note 1) | Steady State | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | -200 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$ |  | -140 |  |
|  | $\mathrm{t} \leq 5 \mathrm{~s}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | -250 |  |
| Power Dissipation (Note 1) | Steady State | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 125 | mW |
|  | $\mathrm{t} \leq 5 \mathrm{~s}$ |  |  | 200 |  |
| Pulsed Drain Current | N-Channel | $\mathrm{t}_{\mathrm{p}}=10 \mu \mathrm{~s}$ | $\mathrm{I}_{\mathrm{DM}}$ | 800 | mA |
|  | P-Channel |  |  | -600 |  |
| Operating Junction and Storage Temperature |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{J},} \\ \mathrm{~T}_{\mathrm{STG}} \end{gathered}$ | $\begin{gathered} -55 \text { to } \\ 150 \end{gathered}$ | ${ }^{\circ} \mathrm{C}$ |
| Source Current (Body Diode) (Note 2) |  |  | Is | 200 | mA |
| Lead Temperature for Soldering Purposes ( $1 / 8^{\prime \prime}$ from case for 10 s ) |  |  | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz Cu.
2. Pulse Test: pulse width $\leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$

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| $\mathrm{V}_{\text {(BR) }{ }^{\text {DSS }}}$ | $\mathrm{R}_{\mathrm{DS} \text { (on) }}$ Max | $\mathrm{I}_{\mathrm{D}} \mathrm{Max}$ |
| :---: | :---: | :---: |
| $\begin{aligned} & \mathrm{N} \text {-Channel } \\ & 20 \mathrm{~V} \end{aligned}$ | $1.5 \Omega$ @ 4.5 V | 0.22 A |
|  | $2.0 \Omega$ @ 2.5 V |  |
|  | $3.0 \Omega$ @ 1.8 V |  |
|  | $4.5 \Omega$ @ 1.5 V |  |
| $\begin{aligned} & \text { P-Channel } \\ & 20 \mathrm{~V} \end{aligned}$ | $5.0 \Omega$ @ -4.5V | -0.2 A |
|  | $6.0 \Omega$ @ -2.5 V |  |
|  | $7.0 \Omega$ @ -1.8V |  |
|  | $10 \Omega @-1.5 \mathrm{~V}$ |  |

PINOUT: SOT-963


## ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| NTUD3169CZT5G | SOT-963 <br> (Pb-Free) | $8000 /$ <br> Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Max | Unit |
| :---: | :---: | :---: | :---: |
| Junction-to-Ambient - Steady State, Minimum Pad (Note 3) | $\mathrm{R}_{\text {өJA }}$ | 1000 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction-to-Ambient - t $\leq 5 \mathrm{~s}$ (Note 3) |  | 600 |  |

3. Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.

ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Parameter | Symbol | N/P | Test Condition |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS |  |  |  |  |  |  |  |  |
| Drain-to-Source Breakdown Voltage | $V_{(B R) D S S}$ | N | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 20 |  |  | V |
|  |  | P |  | $\mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ | -20 |  |  |  |
| Zero Gate Voltage Drain Current | $\mathrm{I}_{\text {dss }}$ | N | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=5.0 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | 50 | nA |
|  |  |  |  | $\mathrm{T}_{\mathrm{J}}=85^{\circ} \mathrm{C}$ |  |  | 200 |  |
|  |  | P | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-5.0 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | -50 |  |
|  |  |  |  | $\mathrm{T}_{\mathrm{J}}=85^{\circ} \mathrm{C}$ |  |  | -200 |  |
| Zero Gate Voltage Drain Current | IDSs | N | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=16 \mathrm{~V}$ | $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ |  |  | 100 | nA |
|  |  | P | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-16 \mathrm{~V}$ |  |  |  | -100 |  |
| Gate-to-Source Leakage Current | IGSS | N | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 5.0 \mathrm{~V}$ |  |  |  | $\pm 100$ | nA |
|  |  | P |  |  |  |  | $\pm 100$ |  |

ON CHARACTERISTICS (Note 4)

| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}(\mathrm{TH})$ | N | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}$ | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 0.4 |  | 1.0 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | P |  | $\mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ | -0.4 |  | -1.0 |  |
| Drain-to-Source On Resistance | $\mathrm{R}_{\mathrm{DS} \text { (on) }}$ | N | $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=100 \mathrm{~mA}$ |  |  | 0.75 | 1.5 | $\Omega$ |
|  |  | P | $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-100 \mathrm{~mA}$ |  |  | 2.0 | 5.0 |  |
|  |  | N | $\mathrm{V}_{\mathrm{GS}}=2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=50 \mathrm{~mA}$ |  |  | 1.0 | 2.0 |  |
|  |  | P | $\mathrm{V}_{\mathrm{GS}}=-2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-50 \mathrm{~mA}$ |  |  | 2.6 | 6.0 |  |
|  |  | N | $\mathrm{V}_{\mathrm{GS}}=1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~mA}$ |  |  | 1.4 | 3.0 |  |
|  |  | P | $\mathrm{V}_{\mathrm{GS}}=-1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-20 \mathrm{~mA}$ |  |  | 3.4 | 7.0 |  |
|  |  | N | $\mathrm{V}_{\mathrm{GS}}=1.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=10 \mathrm{~mA}$ |  |  | 1.8 | 4.5 |  |
|  |  | P | $\mathrm{V}_{\mathrm{GS}}=-1.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-10 \mathrm{~mA}$ |  |  | 4.0 | 10 |  |
|  |  | N | $\mathrm{V}_{\mathrm{GS}}=1.2 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.0 \mathrm{~mA}$ |  |  | 2.8 |  |  |
|  |  | P | $\mathrm{V}_{\mathrm{GS}}=-1.2 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-1.0 \mathrm{~mA}$ |  |  | 6.0 |  |  |
| Forward Transconductance | grs | N | $\mathrm{V}_{\mathrm{DS}}=5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=125 \mathrm{~mA}$ |  |  | 0.48 |  |  |
|  |  | P | $\mathrm{V}_{\mathrm{DS}}=-5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-125 \mathrm{~mA}$ |  |  | 0.35 |  | S |
| Source-Drain Diode Voltage | $\mathrm{V}_{S D}$ | N | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$, $\mathrm{I}_{\mathrm{S}}=10 \mathrm{~mA}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  | 0.6 | 1.0 | V |
|  |  | P | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA}$ |  |  | -0.6 | -1.0 |  |

## CAPACITANCES

| Input Capacitance | $\mathrm{Cl}_{\text {ISS }}$ | N | $\begin{gathered} f=1 \mathrm{MHz}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{DS}}=15 \mathrm{~V} \end{gathered}$ | 12.5 | pF |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Capacitance | Coss |  |  | 3.6 |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {RSS }}$ |  |  | 2.6 |  |
| Input Capacitance | $\mathrm{C}_{\text {ISS }}$ | P | $\begin{gathered} f=1 \mathrm{MHz}, V_{G S}=0 V \\ V_{D S}=-15 V \end{gathered}$ | 13.5 |  |
| Output Capacitance | Coss |  |  | 3.8 |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {RSS }}$ |  |  | 2.0 |  |

4. Switching characteristics are independent of operating junction temperatures

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ELECTRICAL CHARACTERISTICS $\left(T_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Parameter | Symbol | N/P | Test Condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SWITCHING CHARACTERISTICS, $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ (Note 4) |  |  |  |  |  |  |  |
| Turn-On Delay Time | $\mathrm{t}_{\mathrm{d}(\mathrm{ON})}$ | N | $\begin{gathered} \mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=200 \mathrm{~mA}, \\ \mathrm{R}_{\mathrm{G}}=2.0 \Omega \end{gathered}$ |  | 16.5 |  | ns |
| Rise Time | $\mathrm{t}_{\mathrm{r}}$ |  |  |  | 25.5 |  |  |
| Turn-Off Delay Time | $\mathrm{t}_{\mathrm{d} \text { (OFF) }}$ |  |  |  | 142 |  |  |
| Fall Time | $\mathrm{t}_{\mathrm{f}}$ |  |  |  | 80 |  |  |
| Turn-On Delay Time | $\mathrm{t}_{\mathrm{d}(\mathrm{ON})}$ | P | $\begin{gathered} \mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=-15 \mathrm{~V}, \\ \mathrm{I}_{\mathrm{D}}=-200 \mathrm{~mA}, \mathrm{R}_{\mathrm{G}}=2.0 \Omega \end{gathered}$ |  | 26 |  |  |
| Rise Time | $\mathrm{t}_{\mathrm{r}}$ |  |  |  | 46 |  |  |
| Turn-Off Delay Time | $\mathrm{t}_{\mathrm{d}(\mathrm{OFF})}$ |  |  |  | 196 |  |  |
| Fall Time | $\mathrm{t}_{\mathrm{f}}$ |  |  |  | 145 |  |  |

4. Switching characteristics are independent of operating junction temperatures

## NTUD3169CZ

TYPICAL CHARACTERISTICS (N-CHANNEL)


Figure 1. On-Region Characteristics

$V_{G S}$, GATE-TO-SOURCE VOLTAGE (V)
Figure 3. On-Resistance vs. Gate Voltage


Figure 5. On-Resistance Variation with Temperature


Figure 2. Transfer Characteristics


Figure 4. On-Resistance vs. Drain Current and Gate Voltage


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS (N-CHANNEL)


GATE-TO-SOURCE AND DRAIN-TO-SOURCE VOLTAGE (V)
Figure 7. Capacitance Variation


Figure 8. Resistive Switching Time Variation vs. Gate Resistance


Figure 9. Diode Forward Voltage vs. Current

## NTUD3169CZ

## TYPICAL CHARACTERISTICS (P-CHANNEL)



VDS , DRAIN-TO-SOURCE VOLTAGE (V)
Figure 10. On-Region Characteristics
$\mathrm{V}_{\mathrm{GS}}$, GATE-TO-SOURCE VOLTAGE (V)
Figure 12. On-Resistance vs. Gate Voltage


Figure 14. On-Resistance Variation with Temperature


VGs, GATE-TO-SOURCE VOLTAGE (V)
Figure 11. Transfer Characteristics


Figure 13. On-Resistance vs. Drain Current and Gate Voltage


Figure 15. Drain-to-Source Leakage Current vs. Voltage

## NTUD3169CZ

TYPICAL CHARACTERISTICS (P-CHANNEL)


Figure 16. Capacitance Variation


Figure 17. Resistive Switching Time Variation vs. Gate Resistance


Figure 18. Diode Forward Voltage vs. Current

SOT-963
CASE 527AD-01 ISSUE E
SCALE 4:1


TOP VIEW


SIDE VIEW

$$
\text { BOTTOM VIEW } \begin{array}{|l|l|l|l|}
\hline & 0.08 & \mathrm{X} & \mathrm{Y} \\
\hline
\end{array}
$$

STYLE 1:
PIN 1. EMITTER 1 2. BASE 1
3. COLLECTOR 2
4. EMITTER 2
5. BASE 2
6. COLLECTOR 1

STYLE 4:
PIN 1. COLLECTOR
2. COLLECTOR
3. BASE
4. EMITTER
5. COLLECTOR
6. COLLECTOR

STYLE 7 :
PIN 1. CAThode
2. ANODE
3. CATHODE
4. CATHODE
5. ANODE
6. CATHODE

STYLE 10:
PIN 1. CATHODE 1
2. $\mathrm{N} / \mathrm{C}$
3. CATHODE 2
4. ANODE 2
5. $\mathrm{N} / \mathrm{C}$
6. ANODE 1

STYLE 2:
PIN 1. EMITTER 1
2. EMITTER2
3. BASE 2
4. COLLECTOR 2
5. BASE 1
6. COLLECTOR 1

STYLE 5:
PIN 1. CATHODE
2. CATHODE
3. ANODE
4. ANODE
5. CATHODE

STYLE 8:
PIN 1. DRAIN
2. DRAIN
3. GATE
4. SOURCE
5. DRAIN
6. DRAIN

STYLE 3:
PIN 1. CATHODE 1
2. CATHODE 1
3. ANODE/ANODE 2
4. CATHODE 2
6. ANODE/ANODE 1

STYLE 6:
PIN 1. CATHODE
2. ANODE
2. ANTHEDE
3. CATHODE
4. CATHODE
6. CATHODE

STYLE 9:
PIN 1. SOURCE 1
2. GATE 1
3. DRAIN 2
4. SOURCE 2
5. GATE 2
6. DRAIN 1

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NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S
SSM6P69NU,LF DMP22D4UFO-7B DMN1006UCA6-7

